

DATASHEET

Technical Data Sheet 1.6mm round Subminiature Infrared LED HIR26-81B/L423/2T

Features

- Compatible with infrared and vapor phase reflow solder process.
- Small double-end package
- Peak wavelength λp=850nm
- Package in 8mm tape on 7" diameter reel.
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free.(Br<900 ppm,Cl<900 ppm,Br+Cl<1500 ppm)

Description

• HIR26-81B/L423/2T is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor

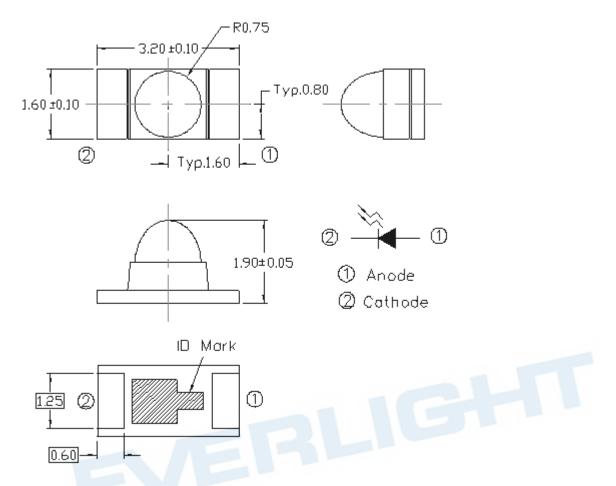
Applications

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Gas Counter
- Infrared applied system

Device Selection Guide

Device No.	Chip Material	Lens Color	
HIR26-81B/L423/2T	AlGaAs	Black	

Package Dimensions



Notes: 1. All dimensions are in millimeters

- 2.Tolerances unless dimensions ±0.1mm
- 3.Suggested pad dimension is just for reference only Please modify the pad dimension based on individual need



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I_{F}	70	mA
Peak Forward Current *1	I_{FSM}	700	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}$
Storage Temperature	T_{stg}	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Soldering Temperature *2	T_{sol}	260	$^{\circ}$ C
Power Dissipation at(or below) 25°C Free Air Temperature	P_d	140	mW

Notes: *1: I_{FP} Conditions--Pulse Width $\leq 10\mu$ s and Duty=0.

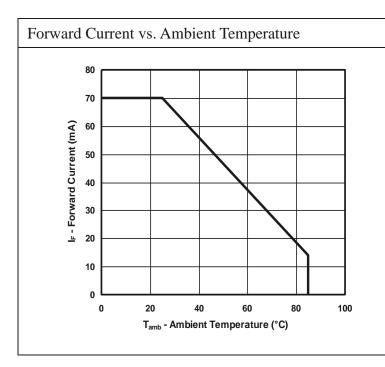
Electro-Optical Characteristics (Ta=25°C)

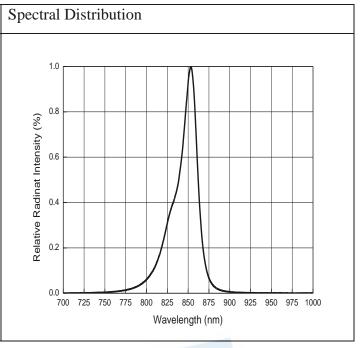
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Radiant Intensity	Ie	18	25		mW/sr	I _F =20mA
		63	1-1	200		I _F =70mA Pulse Width=20ms
Peak Wavelength	λр		850		nm	I _F =20mA
Spectral Bandwidth	Δλ		30		nm	I _F =20mA
Forward Voltage	V_{F}	1.20	1.45	1.70	V	I _F =20mA
		1.40	1.60	2.00		I _F =70mA Pulse Width=20ms
Reverse Current	I_R			10	μA	V _R =5V
View Angle	$2\theta_{1/2}$		20		deg	I _F =20mA

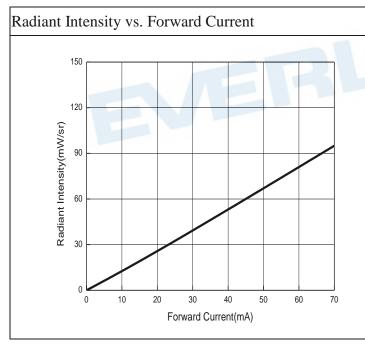
^{*2:}Soldering time \leq 5 seconds.

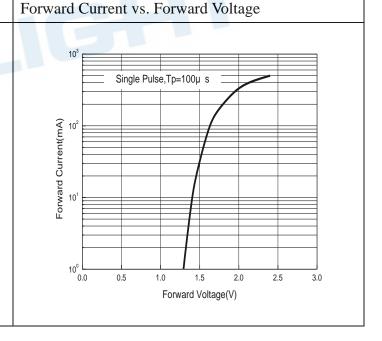


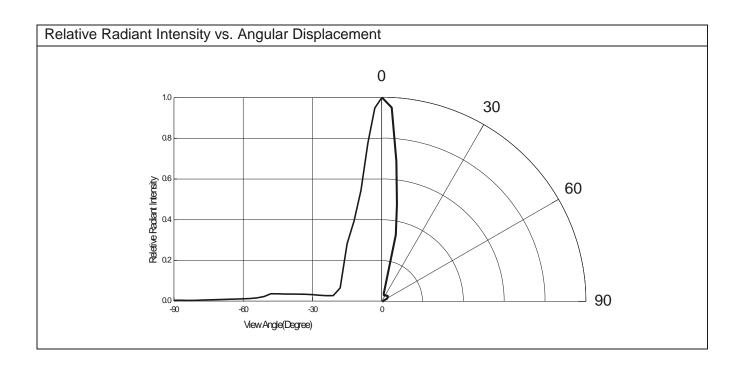
Typical Electrical/Optical/Characteristics Curves















Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

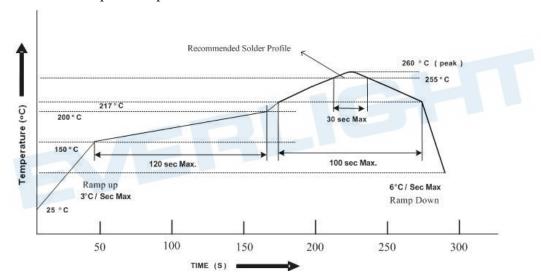
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for Min. 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

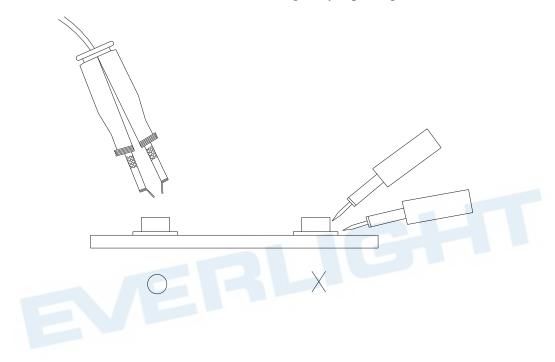


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

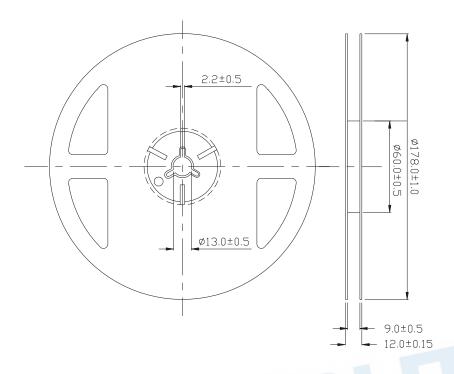
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



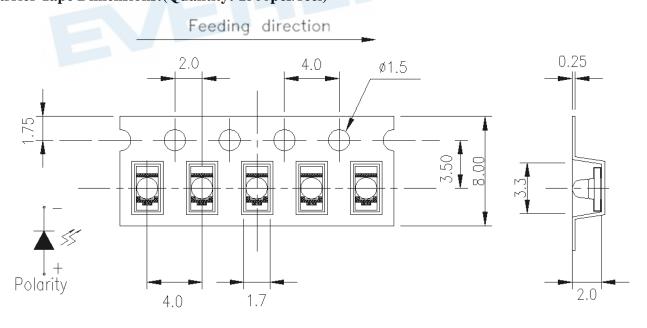


Package Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

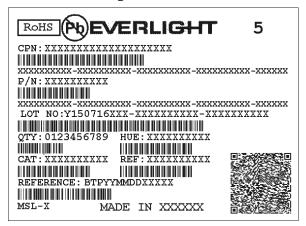
Carrier Tape Dimensions:(Quantity: 1500pcs/reel)



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Label Form Specification



CPN: Customer's Production Number

P/N: Production Number

LOT No: Lot Number QTY: Packing Quantity HUE: Peak Wavelength

CAT: Ranks

REF: Reference
MSL-X: MSL Level

Made In: Manufacture place

DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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